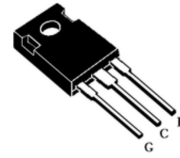


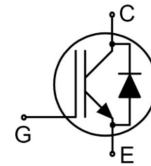
## Features

- Low gate charge
- FS Technology
- Saturation voltage:  $V_{CE(sat),typ} = 1.75V @ I_C=25A$  and  $T_C=25^\circ C$
- RoHS product



## Applications

- General purpose inverters
- Induction heating(IH)
- UPS



| Order Codes  | Marking      | Package |
|--------------|--------------|---------|
| MSG25T120FQC | MSG25T120FQC | TO-247  |

## Absolute Ratings (T<sub>c</sub>=25°C)

| Parameter  | Symbol                              | MSG25T120FQC | Unit |
|--|-------------------------------------|--------------|------|
| Collector-Emitter Voltage                          | V <sub>ces</sub>                    | 1200         | V    |
| Collector Current-continuous                       | I <sub>c</sub> T=25°C               | 50           | A    |
|  |                                     | 25           | A    |
| Collector Current-pulse(note 1)                    | I <sub>CM</sub>                     | 60           | A    |
| Diode forward current<br>@ T <sub>C</sub> = 100°C  | I <sub>F</sub>                      | 25           | A    |
| Gate-Emitter Voltage                               | V <sub>GES</sub>                    | ±20          | V    |
| Turn-off safe area                                 | -                                   | 60           | A    |
| Power Dissipation                                  | P <sub>D</sub> T <sub>C</sub> =25°C | 350          | W    |
| Diode Forward Current                              | T <sub>C</sub> =100°C               | 25           | A    |
| Operating and Storage<br>Temperature Range         | T <sub>J</sub> , T <sub>STG</sub>   | -55~+150     | °C   |
| Maximum Lead Temperature for<br>Soldering Purposes | T <sub>L</sub>                      | 300          | °C   |

Collector current limited by maximum junction temperature

## Thermal Characteristic

| Parameter           | Symbol | Tests conditions | Min | Typ | Max | Units |
|---------------------|--------|------------------|-----|-----|-----|-------|
| Off-Characteristics |        |                  |     |     |     |       |

|  |                              |  |      |      |      |      |
|--|------------------------------|--|------|------|------|------|
| Collector-Emitter Voltage                                      | $BV_{CES}$                   | $I_C=500\mu A, V_{GE}=0V$  | 1200 | -    | -    | V    |
| Breakdown Voltage Temperature Coefficient                      | $\Delta BV_{CES}/\Delta T_J$ | $I_C=1mA$ , referenced to 25°C   | -    | 0.6  | -    | V/°C |
| Zero Gate Voltage Collector Current                            | $I_{CES}$                    | $V_{CE}=1200V, V_{GE}=0V, T_C=25^\circ C$                                    | -    | -    | 0.2  | mA   |
|  |                              | $T_C=100^\circ C$  | -    | -    | 2    | mA   |
|  |                              | $T_C=150^\circ C$  | -    | -    | 2.5  | mA   |
| Gate-body leakage current, forward                             | $I_{GESF}$                   | $V_{CE}=0V, V_{GE}=-20V$   | -    | -    | -100 | nA   |
| <b>On-Characteristics</b>                                      |                              |  |      |      |      |      |
| Gate-Emitter Threshold Voltage                                 | $V_{GE(th)}$                 | $V_{CE}=V_{GE}, I_C=600\mu A$  | 4.5  | -    | 6.5  | V    |
| Collector-Emitter saturation Voltage                           | $V_{CESAT}$                  | $V_{GE}=15V, I_C=25A$  | -    | 1.75 | 2.5  | V    |
|  |                              | $T_C=25^\circ C$   | -    | 2    | -    |      |
|  |                              | $T_C=150^\circ C$  | -    | 2.1  | -    |      |
| Short Collector current (Note 2)                               | $I_C(sc)$                    | $V_{GE}=15V$<br>$V_{CE}=600V$ tsc< 10us<br>$T_C=25^\circ C$                  |      | 160  |      | A    |
| <b>Dynamic Characteristics</b>                                 |                              |  |      |      |      |      |
| Input capacitance  | $C_{ies}$                    | $V_{CE}=25V,$<br>$V_{GE}=0V,$<br>$f=1.0MHz$                                  | -    | 1600 | 2400 | pF   |
| Output capacitance   | $C_{oes}$                    |  | -    | 120  | 190  | pF   |
| Reverse transfer capacitance                                   | $C_{res}$                    |  | -    | 80   | 130  | pF   |
| <b>Switching Characteristics</b>                               |                              |  |      |      |      |      |
| Turn-On delay time   | $t_d(on)$                    | $V_{CE}=600V, I_C=25A,$<br>$R_G=10\Omega$<br>$T_C=25^\circ C$ Inductive Load | -    | 93   | -    | ns   |
| Turn-On rise time  | $t_r$                        |  | -    | 77   | -    | ns   |
| Turn-off delay time  | $t_d(off)$                   |  | -    | 216  | -    | ns   |
| Turn-off Fall time   | $t_f$                        |  | -    | 108  | -    | ns   |
| Turn-on energy   | $E_{on}$                     |  | -    | 2.8  | -    | mJ   |
| Turn-off energy  | $E_{off}$                    |  | -    | 1.0  | -    | mJ   |
| Total switching Energy   | $E_{total}$                  |  | -    | 3.8  | -    | mJ   |
| Total Gate Charge  | $Q_g$                        | $V_{CE}=600V, I_C=25A,$<br>$V_{GE}=15V$ (note3,4)                            | -    | 120  | -    | nC   |
| <b>Anti-Paraller Diode Characteristics and Maximum Ratings</b> |                              |  |      |      |      |      |
| Diode Forward Voltage  | $V_F$                        | $V_{GE}=0V, I_F=25A$   | -    | 1.77 | 2.8  | V    |

|                             |                 |  |   |     |   |    |
|-----------------------------|-----------------|--|---|-----|---|----|
| Diode Reverse recovery time | $t_{rr}$        | V <sub>GE</sub> =0V, V <sub>R</sub> =800V<br>I <sub>F</sub> =25A | - | 236 | - | ns |
| Reverse recovery charge     | Q <sub>rr</sub> | di/dt=200/us (note 4)  | - | 1.3 | - | uC |

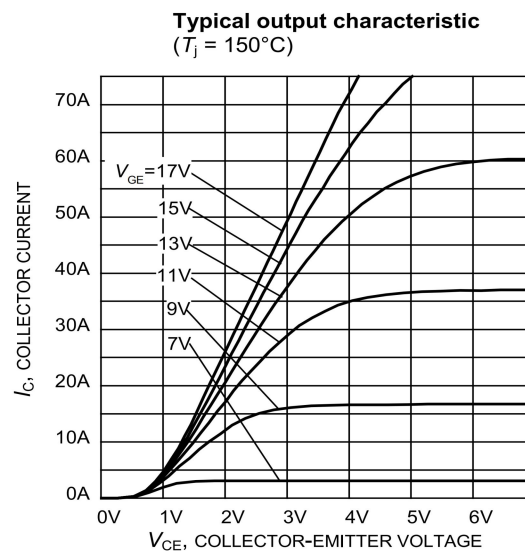
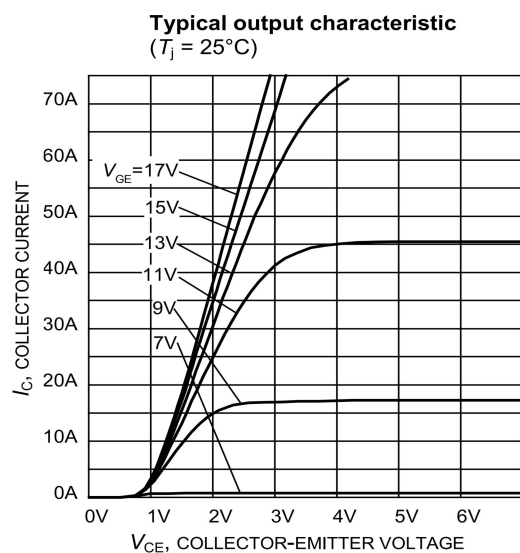
### Thermal characteristics

| Symbol               | Parameter                                | Max | Unit |
|----------------------|--|-----|------|
| R <sub>th(j-c)</sub> | Thermal Resistance, Junction to Case     | 0.4 | °C/W |
| R <sub>th(j-A)</sub> | Thermal Resistance, Junction to Ambience | 40  | °C/W |

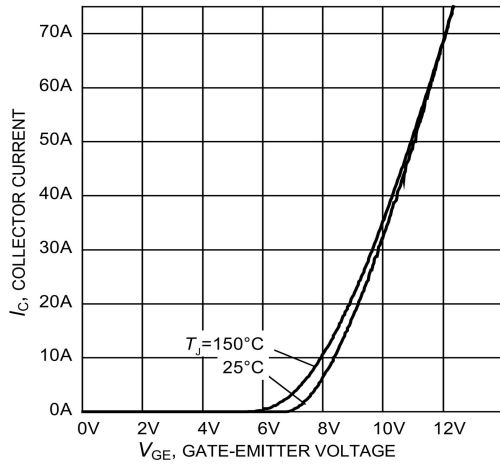
Notes:

- 1: Pulse width limited by maximum junction temperature
- 2: Allowed number of short circuits:<1000; time between short circuits:>1s.
- 3: Pulse Test: Pulse Width ≤300us, Duty Cycles2%
- 4: Essentially independent of operating temperature

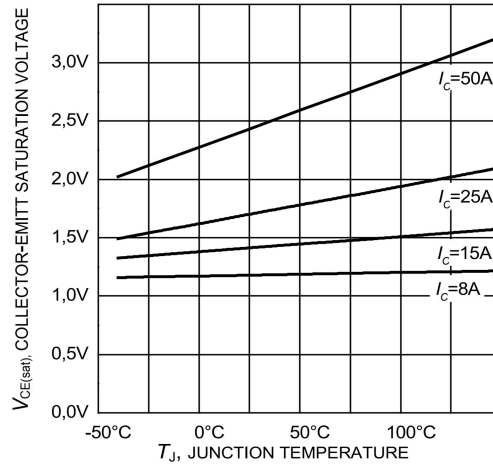
### Electrical Characteristics(curves)



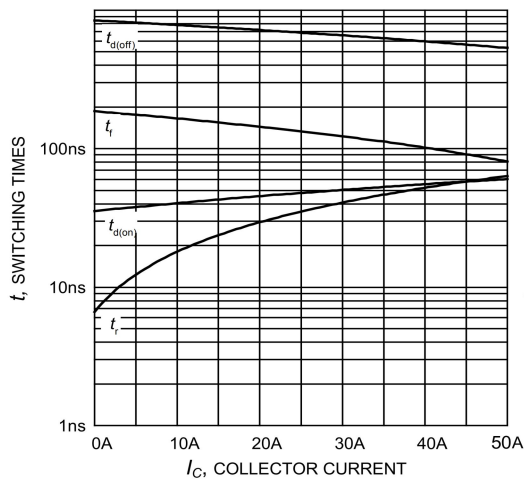
**Typical transfer characteristic**  
( $V_{CE}=20V$ )



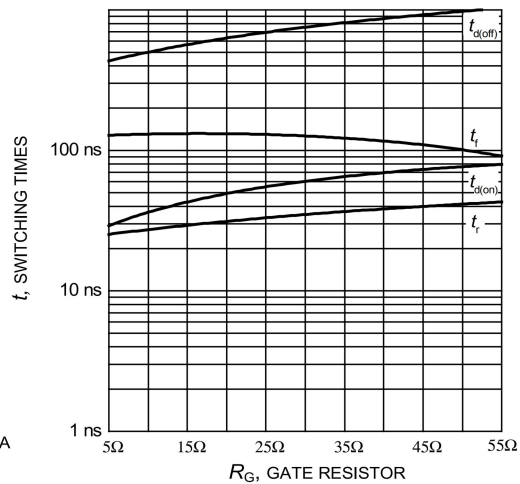
**Typical collector-emitter saturation voltage as a function of junction temperature**  
( $V_{GE} = 15V$ )



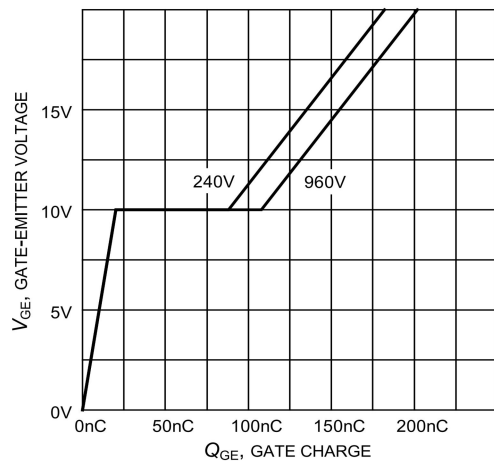
**Typical switching times as a function of gate resistor** (inductive load,  $T_J=150^\circ C$ ,  $V_{CE}=600V$ ,  $V_{GE}=0/15V$ ,  $R_G=22\Omega$ )



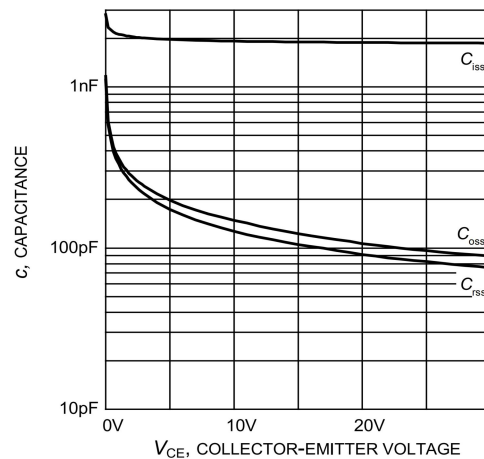
**Typical switching times as a function of gate resistor** (inductive load,  $T_J=150^\circ C$ ,  $V_{CE}=600V$ ,  $V_{GE}=0/15V$ ,  $I_C=25A$ )



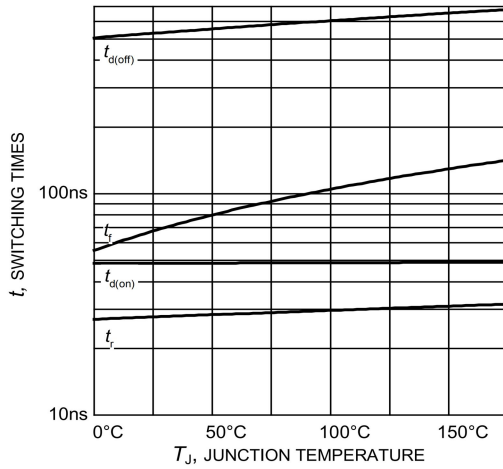
**Typical gate charge** ( $I_C=25A$ )



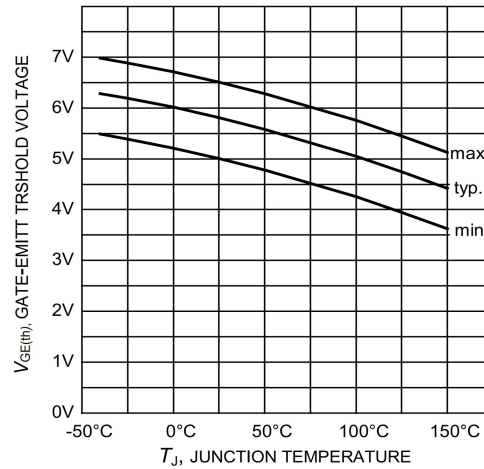
**Typical capacitance as a function of collector-emitter voltage**  
( $V_{GE}=0V$ ,  $f = 1 MHz$ )



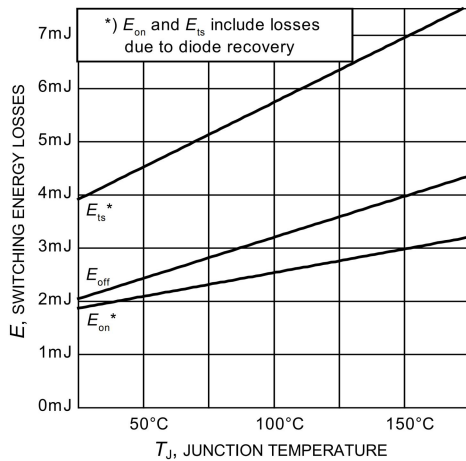
**Typical switching times as a function of junction temperature** (inductive load,  $V_{CE}=600V$ ,  $V_{GE}=0/15V$ ,  $I_C=25A$ ,  $R_G=22\Omega$ .)



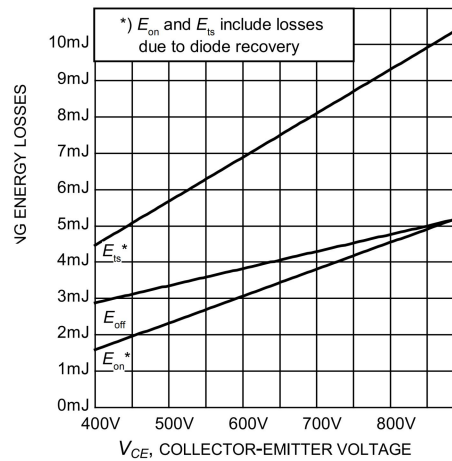
**Gate-emitter threshold voltage as a function of junction temperature** ( $I_C = 1.0mA$ )



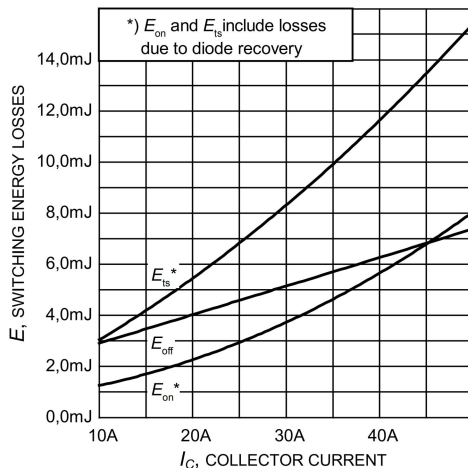
**Typical switching energy losses as a function of junction temperature** (inductive load,  $V_{CE}=600V$ ,  $V_{GE}=0/15V$ ,  $I_C=25A$ ,  $R_G=22\Omega$ )



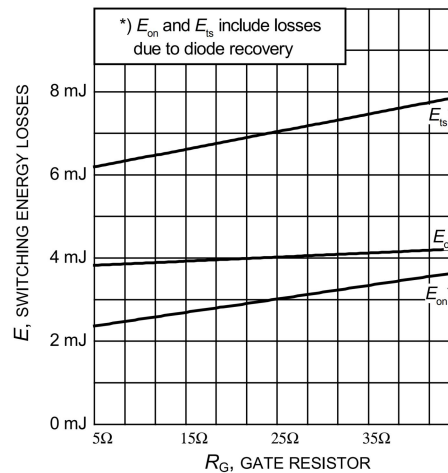
**Typical switching energy losses as a function of collector emitter voltage** (inductive load,  $V_{GE}=0/15V$ ,  $I_C=25A$ ,  $R_G=22\Omega$ ,  $T_J=150^{\circ}C$ .)



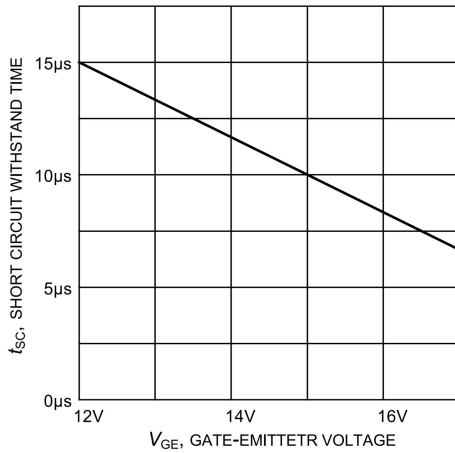
**Typical switching energy losses as a function of collector current** (inductive load,  $T_J=150^{\circ}C$ ,  $V_{CE}=600V$ ,  $V_{GE}=0/15V$ ,  $R_G=22\Omega$ .)



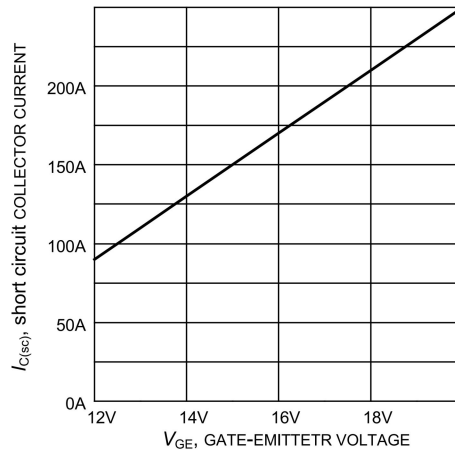
**Typical switching energy losses as a function of gate resistor** (inductive load,  $T_J=150^{\circ}C$ ,  $V_{CE}=600V$ ,  $V_{GE}=0/15V$ ,  $I_C=25A$ .)



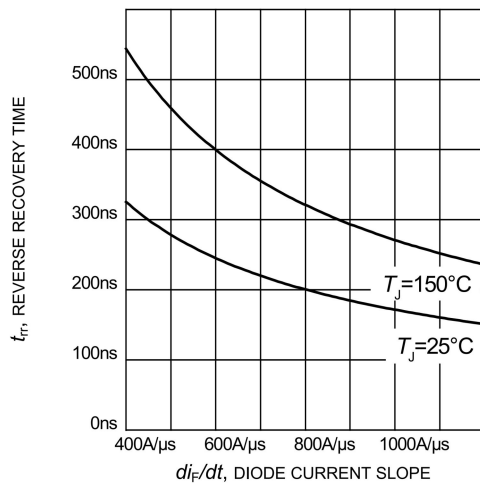
**Short circuit withstand time as a function of gate-emitter voltage**  
( $V_{CE}=600V$ , start at  $T_J=25^\circ C$ )



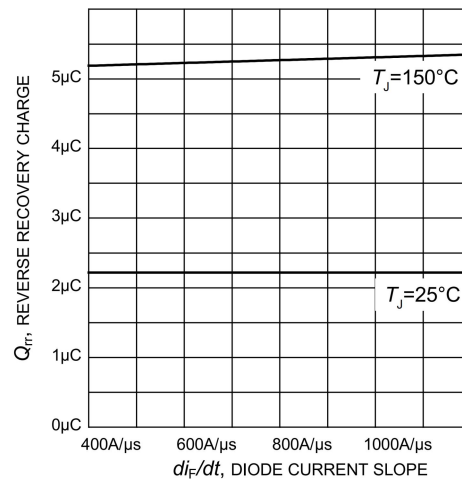
**Typical short circuit collector current as a function of gate-emitter voltage** ( $V_{CE} \leq 600V$ ,  $T_J \leq 150^\circ C$ )



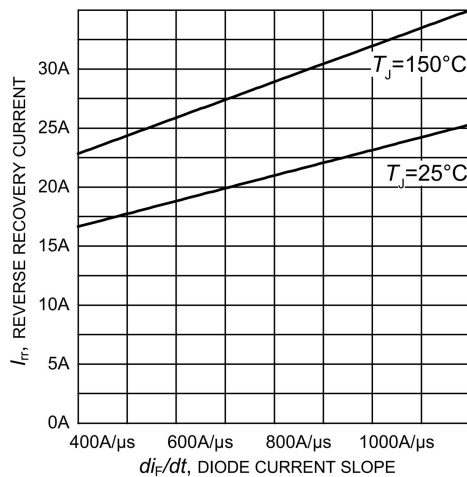
**Typical reverse recovery time as a function of diode current slope** ( $V_R=600V$ ,  $I_F=25A$ )



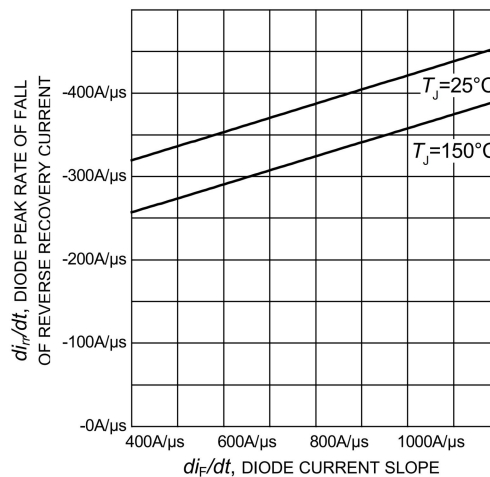
**Typical reverse recovery charge as a function of diode current slope** ( $V_R=600V$ ,  $I_F=25A$ )



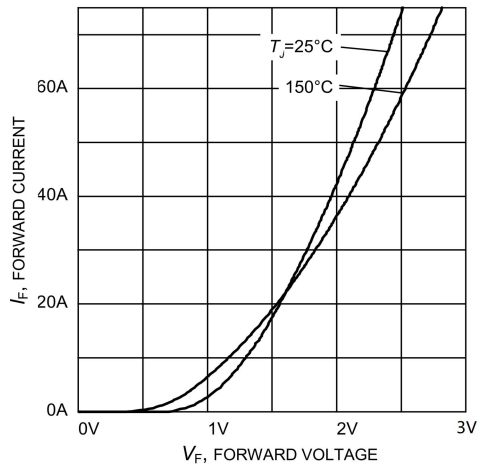
**Typical reverse recovery current as a function of diode current slope**  
( $V_R=600V$ ,  $I_F=25A$ )



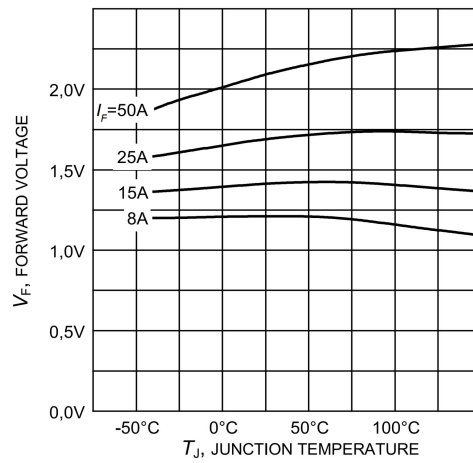
**Typical diode peak rate of fall of reverse recovery current as a function of diode current slope**  
( $V_R=600V$ ,  $I_F=25A$ )



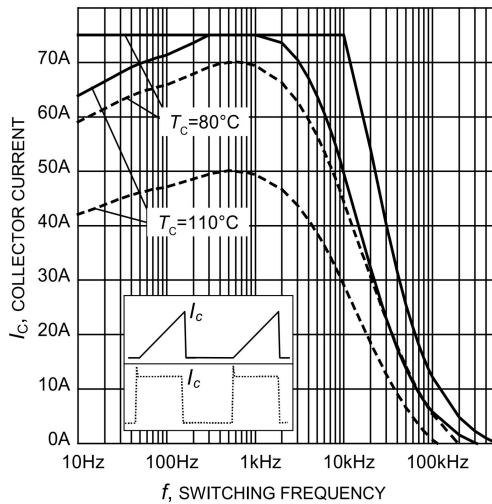
Typical diode forward current as a function of forward voltage



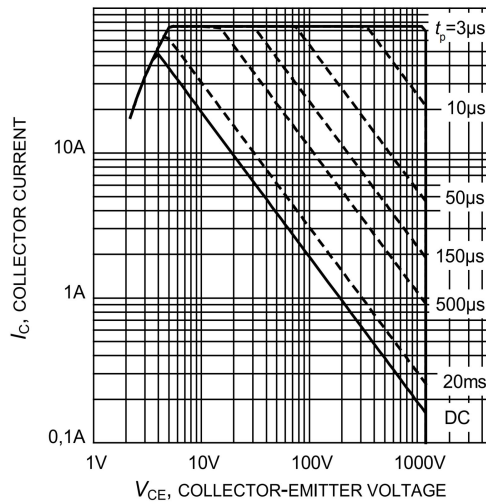
Typical diode forward voltage as a function of junction temperature



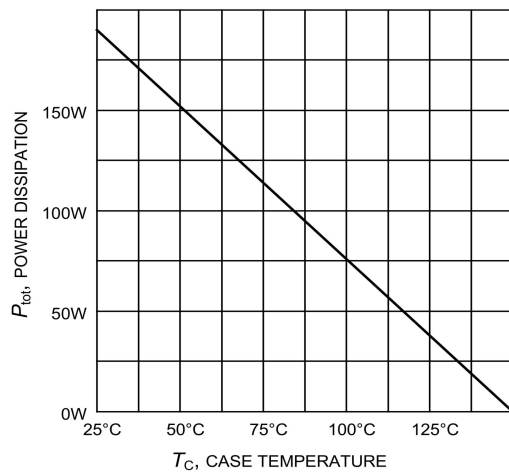
Collector current as a function of switching frequency ( $T_J \leq 150^\circ\text{C}$ ,  $D = 0.5$ ,  $V_{CE} = 600\text{V}$ ,  $V_{GE} = 0/+15\text{V}$ ,  $R_G = 22\Omega$ )



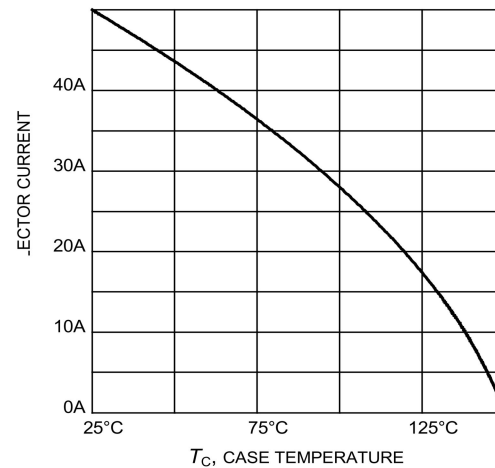
Safe operating area ( $D = 0$ ,  $T_C = 25^\circ\text{C}$ ,  $T_J \leq 150^\circ\text{C}$ ;  $V_{GE} = 15\text{V}$ )



Power dissipation as a function of case temperature ( $T_J \leq 150^\circ\text{C}$ )



Collector current as a function of case temperature ( $V_{GE} \geq 15\text{V}$ ,  $T_J \leq 150^\circ\text{C}$ )



Package Mechanical DATA

